

## Cure monitoring of CFRP composites by dynamic mechanical analyser

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### ABSTRACT

The cure characteristics of the carbon/MTM44-1 epoxy composite prepreg and the neat MTM44-1 epoxy resin are determined and monitored using a dynamic mechanical analyser (DMA). This study will also assess whether the simple containment device recommended by the DMA manufacturer for powder and gel is suitable for prepregs. The device is a disposable 0.1-mm thick stainless steel pocket. The cure behaviour of the packaged materials is compared with that of the unpackaged prepreg. All the samples are cured following the manufacturer's 180°C-isothermal schedule with heating rates of 2°C/min and 5°C/min. The tests highlight that: (i) the cure of composite prepregs and resin can be monitored using a DMA; (ii) the stainless steel pocket does not influence the cure of the prepreg and resin; and (iii) the softening and melting of the uncured resin, the resin low viscosity state, and the subsequent gelation-vitrification-solidification of the resin are noticed with this method.

*Keywords*: Composite; Curing; DMA; Gelation; Vitrification; Dynamic mechanical analysis.

### 1. Introduction

Fibre-reinforced thermoset composites can be manufactured using different processing techniques such as resin transfer moulding (RTM) or autoclave. These processes require curing of the thermosetting matrix at ambient or elevated temperatures, which is a chemical reaction between a resin and a hardener or curing agent. This reaction is referred to as crosslinking reaction. The outcome will be the transformation of the resin from a liquid to a solid by the development of a three-dimensional crosslink network. Since a chemical reaction takes place during this process, it is important to understand the behaviour cure state of the curing resin prior to commercialisation and manufacture of composite structures. Such knowledge will be useful for optimising of the manufacture process and for improving the prediction of the component's mechanical properties.

The behaviour of a curing resin or composite prepreg can be assessed using conventional analytical techniques that provide specific properties of the resin as a function of time and temperature. The most common technique is the differential scanning calorimetry (DSC) which is a thermal analysis technique measuring the thermal transitions occurring within the sample when it is heated, cooled or at isothermal temperature. The rein properties that can be extracted are the degree-of-cure, the heat flow during exotherm, the glass transition temperature and the melting and degradation temperatures [1-3].

Other techniques such as Fourier transformed infrared (FTIR) spectroscopy and rotating or oscillating rheometers can also be used to characterise the cure process of resins. The FTIR method consists of following the evolution of specific functional groups with time and temperature from which the degree-of-conversion of a functional

group can be estimated [3-5]. On the other hand, the variation of the resin viscosity is monitored using rheometers during the initial stage of the cure (prior to gelation) [6,7]. Another technique that can be used to investigate the curing behaviour of thermosetting resins or composite prepregs is the dynamic mechanical analyser (DMA). This consists of measuring the material's viscoelastic properties, namely the storage and loss moduli and the damping factor ( $\tan\delta$ ) over a range of environmental and loading conditions. The majority of the application of DMA is to measure the glass transition temperature of solid or rubbery materials. However, this technique is also suitable to monitor the cure development and the gelation and vitrification transitions in thermosets. Cure monitoring of liquid resins with a DMA is achieved using either an inert impregnation braid or tape made of glass fibres, or a cup and probe or shear piston system [5,8-10]. The disadvantage with the former method is that low viscosity resins cannot be monitored without the risk of contaminating the oven and the drawback with the latter method is that the probe is trapped in the resin when gelation is reached; therefore information about the vitrification of the resin cannot be obtained. On the other hand, composite prepreg can be directly fitted between the DMA clamps in a single cantilever or torsion configuration [1,12]. Depending on the resin viscosity, the use of a thin nylon film enveloping the prepreg may be required in order to avoid the liquid resin from dripping inside the DMA oven [13]. Cure monitoring using the DMA highlighted the different transitions that a thermosetting resin encounters during the crosslinking reaction: the gelation – from a liquid to a rubber – and the vitrification – from a rubber to a glass material [5,8,10,13,14]. The work presented in this paper focuses on assessing whether the use of a container device based on stainless steel pocket has an influence on the cure of a carbon/epoxy prepreg and an epoxy resin, which was monitored by dynamic mechanical analysis (DMA). The use of the pockets is a method recommended by the DMA manufacturer to determine the glass transition temperature of powders, gels and some viscous liquids. Such a device is economical, widely available and easy to set up in the DMA.

## 2. Materials and methods

The materials considered in this study were the unidirectional carbon fibre-reinforced MTM44-1 epoxy prepreg composite and the neat MTM44-1 epoxy resin, both supplied by Umeco Composites. The resin system is a one-part, high-performance, toughened, amine-based epoxy resin. The composite samples were prepared by stacking four layers of the prepreg (uncured ply thickness of 0.125 mm; fibre volume fraction of 60%) in the same direction using a roller to make unidirectional (UD) samples. The reinforcing fibres were all aligned along the length of the samples. The nominal dimensions of the uncured composite samples were 35.61 x 6.18 x 1.08 mm or 12.83 x 6.65 x 1.07 mm.

Regarding the neat epoxy resin, few milligrams (between 14.8 and 22.3 mg) of the material were extracted from a frozen solid block prior testing. Between tests, both materials were stored in a freezer according to the manufacturer's recommendations.

## 3. Experimental processes

### 3.1 Dynamic mechanical analyser

The viscoelastic properties of the curing materials were obtained by means of a Perkin Elmer DMA8000 dynamic mechanical analyser (DMA). The samples were subjected to a controlled sinusoidal displacement of 0.01 mm at the frequencies of 1, 5 and 10 Hz in the single cantilever bending configuration. The storage modulus ( $E'$ ), loss

modulus ( $E''$ ) and damping factor ( $\tan\delta$ ) were monitored as a function of temperature and time.

The free sample length between the fixed and vibrating clamps was about 15 mm for the composite samples and 10 mm for the neat resin. Both materials were tested using the manufacturer's recommended cure schedule: heating from ambient temperature to 180°C at a rate of 2°C/min or 5°C/min, followed by an isotherm at 180°C for up to 240 min.

The composite samples were tested using two methods – with and without a pocket – in order to assess the influence of such a container device on the cure. The stainless steel 'pockets' consisted of rectangular shims (30 x 14 mm) that were cut from a 0.1-mm thick stainless steel plate (supplied by RS) and then folded lengthwise to form the pockets. The 12-mm long composite samples were then placed in the centre of the pockets. The tests with the unpackaged samples (without any pockets) were carried out with the 35-mm long composite samples that were just placed between the DMA clamps. However, in order to avoid bonding of the sample to the clamps, two 5-mm wide and 0.05-mm thick stainless steel foils were wrapped around the composite sample to avoid direct contact of the curing resin with the clamps. The unidirectional composite samples were all placed/clamped in the same direction: with the carbon fibres aligned lengthwise i.e. from the fixed clamp to the vibrating clamp.

The stainless steel pockets were required to monitor the cure of the neat epoxy resin. The few milligrams of the resin were placed in the centre of the pockets. This test was performed to compare the cure characteristics of the resin with those of the packaged composite. Fig. 1 shows a stainless steel pocket and the packaged and unpackaged composite and resin samples.

### **Fig. 1.**

#### *3.2 Rotational rheometer*

The viscosity of the neat MTM44-1 epoxy resin system was assessed using a rotary rheometer (C-VOR 150 Bohlin). Approximately 200 mg of the resin were placed between two 25-mm diameter aluminium discs spaced by a gap of 500  $\mu\text{m}$ . The bottom disc was fixed whereas the top disc rotated. The resin system was tested under a single shear force of 50 Pa. The resin was heated at a rate of 2°C/min or 5°C/min using an extended temperature cell up to the isothermal temperature of 180°C. The initial test temperature was 50°C in order to soften the resin to obtain the required gap between the discs.

## **4. Results and discussion**

### *4.1 Cure monitoring of unpackaged composite*

The progress of the cure of the resin in the unpackaged unidirectional carbon/MTM44-1 epoxy composite can be followed by looking at the storage modulus ( $E'$ ), the loss modulus ( $E''$ ) and the damping factor ( $\tan\delta$ ) curves. Fig. 2 shows the variation of the storage modulus and temperature as a function of time and Fig. 3 presents the variation of  $E'$  and  $\tan\delta$  as a function of time. In these figures, the composite sample was heated up to the isothermal temperature at a rate of 5°C/min. Several important features of interest can be observed.

### **Fig. 2.**

### **Fig. 3.**

#### 4.1.1 Softening of the matrix

The storage modulus of the unpackaged composite sample decreased with increasing time or temperature until it reaches its lowest values at a temperature between 154°C and 165°C (between 26 and 29 min into the test; about 4 min before the start of the isotherm; label (2) in Fig. 2 and Fig. 3). Until about 15 min into the test (at a temperature of around 92°C; label (1) in Fig. 2 and Fig. 3), the curves for the three frequencies of 1, 5 and 10 Hz remained distinct but the frequency influence was gradually attenuated with increasing temperature. The decrease in  $E'$  and the attenuation of the frequency influence were the result of a change in the nature of the composite matrix that gradually softened with the increasing temperature until the resin lowest viscosity was reached between 154°C and 165°C. The decrease in  $E'$  at the start of the heating was also observed in fibre-reinforced epoxy prepregs by Xie *et al.* [10]. In addition, Stark *et al.* [15] also observed the initial influence of the frequency on the storage modulus and its subsequent attenuation with increasing temperature. This resin softening was interpreted by the authors as being the transition from the glassy to the rubbery state of the uncured resin at low temperature.

The storage modulus for each frequency curve initially decreased rapidly until the 5 and 10-Hz curves became inseparable (at a temperature of about 65°C; 9 min into the test; label (1a) in Fig. 2 and Fig. 3). At a temperature below 65°C, the values of  $E'$  increased with increasing frequency. Above 65°C, the storage modulus continued decreasing at a lower rate up to the temperature of around 95°C (15 min into the test; label (1) in Fig. 2 and Fig. 3), at which point the 1-Hz curve commingled with the other two frequency curves. This highlighted the frequency dependence of the composite prepreg at low temperature when the uncured epoxy resin was in the glassy state. From 95°C to 154-165°C (between 26 and 29 min into the test; label (2) in Fig. 2 and Fig. 3), the storage modulus carried on decreasing until it reaches its lowest values. The unification of all three frequencies (label (1) in Fig. 3) was highlighted by a first minor peak in the  $\tan\delta$  curve, whereas the resin low viscosity was characterised by a trough following this minor peak.

The variation of the viscosity of the MTM44-1 epoxy resin and the cure temperature are presented in Fig. 4 as a function of time. The sample was heated to the isothermal temperature at a rate of 5°C/min. It was observed that the resin viscosity gradually decreased with increasing temperature until a low viscosity state was reached about 22 min into the test (this was obtained about 3 min before the start of the isotherm), after which the viscosity increased rapidly during gelation of the resin until solidification. The time corresponding to the low viscosity obtained by the rheometer was consistent with that for the low  $E'$  values measured by the DMA.

#### Fig. 4.

#### 4.1.2 Gelation of the matrix

After reaching its lowest values, the storage modulus of the epoxy resin in the unpackaged composite increased with increasing temperature up to the isothermal temperature of 180°C and with increasing time. The  $E'$  increase started at a moderate rate until about 40 min into the test (label (3) in Fig. 2 and Fig. 3) and then increased rapidly until 50 min into the test (label (4) in Fig. 2 and Fig. 3). Similar  $E'$  increases were observed in various studies when the isothermal temperature was reached [13,15]. These increases in  $E'$  corresponded to a change in the resin viscosity that was due to the start of the crosslinking reaction, which raises the average molecular

weight of the resin close to infinity [2,9]. As a result, the resin underwent a transition from a liquid state to a solid state representing a change in the mechanical properties therefore it started responding elastically to the imposed DMA loading [13,14]. This transition is referred to as gelation and the beginning of the frequency separation is considered as the gelation point. Fig. 2 and Fig. 3 also show that the start of the crosslinking reaction was independent of the test frequencies since no difference between the frequency curves was noticed. This is dissimilar to the observation made by Stark *et al.* [15] who noted a reduced deviation between the test frequencies. The acceleration of the crosslinking reaction at about 40 min (label (3) in Fig. 3) was highlighted by a second minor peak in the  $\tan\delta$  curve due to the change in the state of the resin.

#### 4.1.3 Vitrification of the matrix

After gelation (about 50 min into the test; label (4) in Fig. 2 and Fig. 3), the  $E'$  values carried on increasing at an even higher rate before gradually levelling out between 84 and 110 min into the test (label (5) in Fig. 2 and Fig. 3). The reason for this rate increase is a change in the behaviour of the epoxy resin under DMA oscillation: it became once again dependent on the oscillation frequencies. This was noticed by the separation of the curves at the different frequencies in both Fig. 2 and Fig. 3. The higher the frequency, the higher the values of  $E'$ . The difference between the frequency curves was gradually accentuated until levelling out. The influence of the frequency on the resin was also noticed in the  $\tan\delta$  where separation of the curves occurred at the start of the major peak (label (4) in Fig. 3). The peak maximum (label (5a) in Fig. 3) was reached during the increase of the storage modulus. The higher the frequency, the earlier the maximum peak was reached: at about 63 min and 71 min for the 10 Hz and 1 Hz frequencies, respectively. The end of the  $\tan\delta$  peak – characterised by a change in the decrease rate – occurred when the storage modulus values started to remain constant between 84 and 110 min depending on the frequency (label (5) in Fig. 3). This rapid increase in storage modulus and the  $\tan\delta$  peak corresponded to the vitrification of the resin – the time in the curing process when the resin solidifies. Vitrification indicates that the cure temperature is approaching or equalling the glass transition temperature of the fully-cured resin due to the transition from a rubbery to a glassy state [5,10]. However, vitrification does not necessarily indicate the end of the formation of the crosslink network.

#### 4.1.4 Solidification of the matrix

From 110 min into the test, the storage modulus remained relatively constant up to the completion of the test. The frequency curves for  $E'$  remained distinct up to about 190 min into the test (label (6) in Fig. 2 and Fig. 3) at which time they were inseparable until the end of the test. This unification of the frequency curves also occurred in the  $\tan\delta$  and this was marked by the curves levelling out. Varley *et al.* [8] stipulated that when the storage modulus levelled out beyond vitrification, the crosslinking reaction was completed. However it does not explain the frequency dependence of the storage modulus and  $\tan\delta$ . A possible explanation is that the separation of the frequency curves could be due to the presence of localised 'volumes' of uncured resin between the nearly-completed principal crosslink network, consequently locking the volumes of resin in a solid structure. The resin in these volumes continued to react until saturation of crosslinks at about 190 min. The presence of these resin volumes had a localised effect on the frequency-dependent storage modulus but no real influence on the

overall modulus of the whole sample ( $E'$  relatively constant whatever the frequency). From 190 min, the sample became an elastic solid material without any 'viscous' properties. Therefore the sample could be considered as being fully cured at that time.

#### 4.1.5 Comparison between the heating rates of 2°C/min and 5°C/min

Heating the composite samples at a heating rate of 2°C/min prior to reaching the isothermal temperature had no real influence on the curing behaviour of the epoxy resin. Similar variations of the storage modulus and  $\tan\delta$  curves were observed but the times at which the glass-rubber transition of the uncured resin occurred and the low viscosity was reached, were increased by 55%. On the other hand, the temperatures at which these features occurred were lower by about 5°C compared with those during a heating rate of 5°C/min. The features observed during the isotherm took place approximately 9 min earlier in the samples heated at a rate of 2°C/min.

#### 4.2 Cure monitoring of packaged composite and resin

One of the advantages of the MTM44-1 epoxy resin is that it remains relatively viscous even when the lowest viscosity threshold is reached; therefore, there was little risk of damage to the DMA instrument from dripping resin. However, should a resin becomes too liquid during cure, a container device such as a stainless steel pocket or nylon film has to be used to assess the curing properties of the resin by the DMA technique [13]. However, such a method could attenuate or even hide some of the curing characteristics of the resin. For this reason, the curing behaviour of the unidirectional carbon/MTM44-1 epoxy prepreg was monitored when the sample was placed in a stainless steel pocket and then compared with the unpackaged composite samples. The cure of the neat epoxy resin was also monitored using a pocket and the resin behaviour was compared with that of the packaged composite.

Isothermal tests on the stainless steel pockets alone confirmed that the storage modulus decreased linearly by less than 5% with increasing temperature, the damping factor remained constant and the frequency did not have any influence on the pocket behaviour. Therefore, the pockets would not have any influence on the visco-elastic behaviour of the curing samples. Consequently, any variations in the storage modulus and  $\tan\delta$  curves would be attributed to the sample.

The curing characteristics of the carbon/epoxy prepreg and the neat epoxy resin contained in stainless steel pockets are shown in Fig. 5 and Fig. 6 respectively, where the storage modulus ( $E'$ ) and the damping factor ( $\tan\delta$ ) are plotted as a function of the test duration (the heating rate was 2°C/min).

**Fig. 5.**

**Fig. 6.**

Most of the curing characteristics observed in the unpackaged composite and described in the previous section can also be noticed in the composite and neat resin contained in stainless steel pockets. The glass to rubber transition of the softening uncured epoxy resin was noticed by a change in the slope of the decreasing storage modulus and  $\tan\delta$  values at the temperature of about 65°C (label (1a) in Fig. 5 and Fig. 6). At that temperature, the frequency curves were generally inseparable in most of the packaged composite and neat resin sample heated at a rate of 2°C/min and in all the samples heated at 5°C/min. In the other samples heated at 2°C/min, the

1 unification of the 1 Hz curve with the other two frequency curves was seen to take  
2 place at about 95°C (label (1) in Fig. 5 and Fig. 6). It can therefore be assumed that  
3 the use of the stainless steel pockets lessened the influence of the frequency on the  
4 softening resin.

5 The low viscosity regime highlighted by the lowest  $E'$  values in both packaged  
6 samples was reached about 3 min before and about 4 min after reaching the  
7 isothermal temperature when the heating rate was 2°C/min and 5°C/min, respectively  
8 (label (2) in Fig. 5 and Fig. 6). This low viscosity state was difficult to observe in the  
9  $\tan\delta$  curves: a slight decrease in the values could be noticed after the  $\tan\delta$  remained  
10 constant during the resin softening process. For a specific heating rate, the values of  
11 the lowest storage modulus and the time when these values were reached were  
12 similar for both packaged materials. On the other hand, the lowest  $E'$  values in the  
13 packaged samples were obtained on average 9 min after those in the unpackaged  
14 samples whatever the heating rate, which could be the result of the thermal effect of  
15 the metallic pockets.

16 In the packaged samples, the gelation of the epoxy resin was highlighted by the  
17 increase of the storage modulus values from the state of low viscosity (label (2) in Fig.  
18 5 and Fig. 6) to the separation of the frequency curves defined as the gelation point  
19 (about 96 min into the test; label (4) in Fig. 5 and Fig. 6). The start of the crosslinking  
20 reaction was not obvious from the damping factor curves but the frequency  
21 dependence of the polymerising resin was marked by a rapid increase in the  $\tan\delta$   
22 values and by a separation of the different frequency curves (label (4) in the figures).  
23 The frequency separation in the packaged samples occurred on average between 3 to  
24 7 min after the separation in the unpackaged samples; however, no time difference  
25 was observed between both packaged materials.

26 Vitrification of the resin in the packaged samples was highlighted by the rapid increase  
27 in the storage modulus values and by the large  $\tan\delta$  peak (labels (5) in Fig. 5 and Fig.  
28 6). At that stage in the cure, the behaviour of the composite and resin was dependent  
29 on the DMA oscillation frequency. The end of vitrification is generally marked by the  
30 levelling of the  $E'$  values and by a change in the  $\tan\delta$  decrease rate, both occurring at  
31 the same time. However, this characteristic was only observed in the packaged  
32 composite and not in the packaged resin. This could be attributed to the larger volume  
33 of resin present in the packaged resin samples than in the packaged composites. The  
34 gradual increase of  $E'$  or gradual decrease of  $\tan\delta$  in the neat resin samples could be  
35 attributed to a further opening of the unreacted epoxide rings that crosslinked with  
36 some remaining amine hardener. The larger volume of packaged neat resin could also  
37 be the reason for the maximum  $\tan\delta$  being reached 20 min later than that for the  
38 packaged composite. However, no time delay was observed between the packaged  
39 and unpackaged composite samples.

40 Solidification of the epoxy resin (label (6) in Fig. 5) was only observed in the packaged  
41 composite samples by a unification of the frequency curves of the storage modulus  
42 and by the damping factor curves remaining constant from about 190-230 min into the  
43 test. Unification of the frequency curves in the neat resin was not observed within the  
44 test duration; however, the difference between the frequency curves was reducing  
45 with time. The unification of the frequency occurred at the same time in both the  
46 packaged and unpackaged composite samples.

#### 4.3 Comparison between unpackaged and packaged samples

47 The use of stainless steel pockets did not greatly influence the visco-elastic behaviour  
48 of the curing composite samples. All the cure characteristics described in the previous  
49 subsections (those labelled in the figures) were observed in the unpackaged and  
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1 packaged samples. However, the full solidification of the neat epoxy resin did not  
2 seem to occur during the test duration as the behaviour of the solid resin remained  
3 influenced by the test frequencies.

4 A thermal/time delay was observed between the packaged and the unpackaged  
5 samples as far as the resin low viscosity state and the gelation point were concerned.  
6 These states were reached in the packaged samples between 3 to 9 min after the  
7 unpackaged samples. This means that the pockets slightly delayed the melting and  
8 crosslinking of the resin during the temperature increase and at the beginning of the  
9 isotherm, which could be the result of the relatively high thermal conductivity and  
10 diffusivity properties of the stainless steel.

11 During the melting of the resin, it was observed that the  $\tan\delta$  curves in the packaged  
12 samples were flatter than in the unpackaged samples. The peaks and troughs  
13 associated with the softening of the resin (label (1)), the resin lowest viscosity (label  
14 (2)) and the acceleration of the crosslinking reaction (label (3)) were only noticed in  
15 the unpackaged composite samples. This means that the stainless steel pockets  
16 might be hiding subtle variations in the resin behaviour due to the material's stiffness.  
17 The other influence of the stainless steel pockets can be seen during the glass to  
18 rubber transition of the uncured resin (at the start of the heating process). In all the  
19 unpackaged samples, the dependence of the resin to the test frequencies was clearly  
20 observed by the separation of the frequency curves until unification when the resin  
21 was liquid enough (labels (1) and (1a)). However, the distinction between the  
22 frequency curves was more difficult to make in most of the packaged composite and  
23 resin samples (after label (1a)). The reason could be attributed to the stiffness of the  
24 pockets compared to that of the softening unpackaged composite at the start of the  
25 material cure schedule.

26 Another difference is in the amplitude of the storage modulus values between the start  
27 of the test at 20°C and the temperature of the lowest viscosity (between 160°C and  
28 180°C). The  $E'$  amplitude was on average 6 times larger in the unpackaged composite  
29 samples than in the packaged composite. For example, the amplitudes for the  
30 samples heated with a rate of 2°C/min and oscillated at the frequency of 1 Hz were  
31 1.21 GPa for the unpackaged sample and 0.25 GPa for the packaged composite.  
32 Moreover, no difference was observed between the  $E'$  amplitudes of both packaged  
33 resin and composite samples. This showed that the stiffness of the pockets influenced  
34 the storage modulus values of the tested material. The amplitude of the storage  
35 modulus in all the samples was found to be reduced by an average of 14% when the  
36 heating rate was increased from 2°C/min to 5°C/min. This could indicate that lower  
37 viscosity might be achieved when the heating rate is low, which would allow better  
38 impregnation of the reinforcing fibres in the composites.

39 Stainless steel pockets of different thicknesses were also used to evaluate their  
40 influence on the cure of the epoxy resin. The other two thicknesses were 0.05 mm and  
41 0.2 mm. It was observed that (i) the thinner the pocket, the noisier the DMA curves,  
42 and (ii) the thinner the pocket, the shorter the time/temperature delay for the low  
43 viscosity state and the gelation point. It was found that a 0.1-mm thick pocket was the  
44 best compromise as far as sample handling and cure monitoring were concerned.

## 53 **5. Conclusions**

54 The isothermal cure of a carbon/epoxy composite prepreg and the neat epoxy resin  
55 was monitored using the dynamic mechanical analyser (DMA) method. Some of the  
56 prepreg samples and the neat resin were packaged in stainless steel pockets and  
57 their visco-elastic behaviour was compared with that of the unpackaged composite  
58 samples. It was found that (i) the cure characteristics such as the glass-rubber  
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1 transition of the uncured resin, the low viscosity state and the gelation-vitrification-  
2 solidification of the resin were detected by the DMA technique, (ii) the pockets did not  
3 greatly affect the cure of the epoxy resin/matrix, and (iii) the pockets did not conceal  
4 the resin cure characteristics. The curing differences between the packaged and  
5 unpackaged samples were found to be (i) a slight time/temperature delay due to the  
6 thermal diffusivity of the stainless steel, and (ii) a reduction in the storage modulus  
7 amplitudes and a suppression of the subtle  $\tan\delta$  variations during softening of the  
8 resin due to the stiffness of the pocket material.

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11 the free supply of the neat MTM44-1 epoxy resin.

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## Figure captions

1 **Fig. 1.** Configurations for the composite and resin samples.  
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3 **Fig. 2.** Storage modulus (log scale) and temperature (linear scale) of the curing  
4 carbon/epoxy composite prepreg as a function of time (heating rate of 5°C/min).  
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7 **Fig. 3.** Storage modulus and damping factor (log scales) of the curing carbon/epoxy  
8 prepreg as a function of time (heating rate of 5°C/min).  
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11 **Fig. 4.** Viscosity variation (log scale) of the MTM44-1 resin measured using a  
12 rheometer (heating rate of 5°C/min).  
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14 **Fig. 5.** Storage modulus and damping factor (linear scales) of a curing carbon/epoxy  
15 composite in a stainless steel pocket as a function of time (heating rate of 2°C/min).  
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18 **Fig. 6.** Storage modulus and damping factor (linear scales) of a curing neat epoxy  
19 resin as a function of time (heating rate of 2°C/min).  
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Figure 1

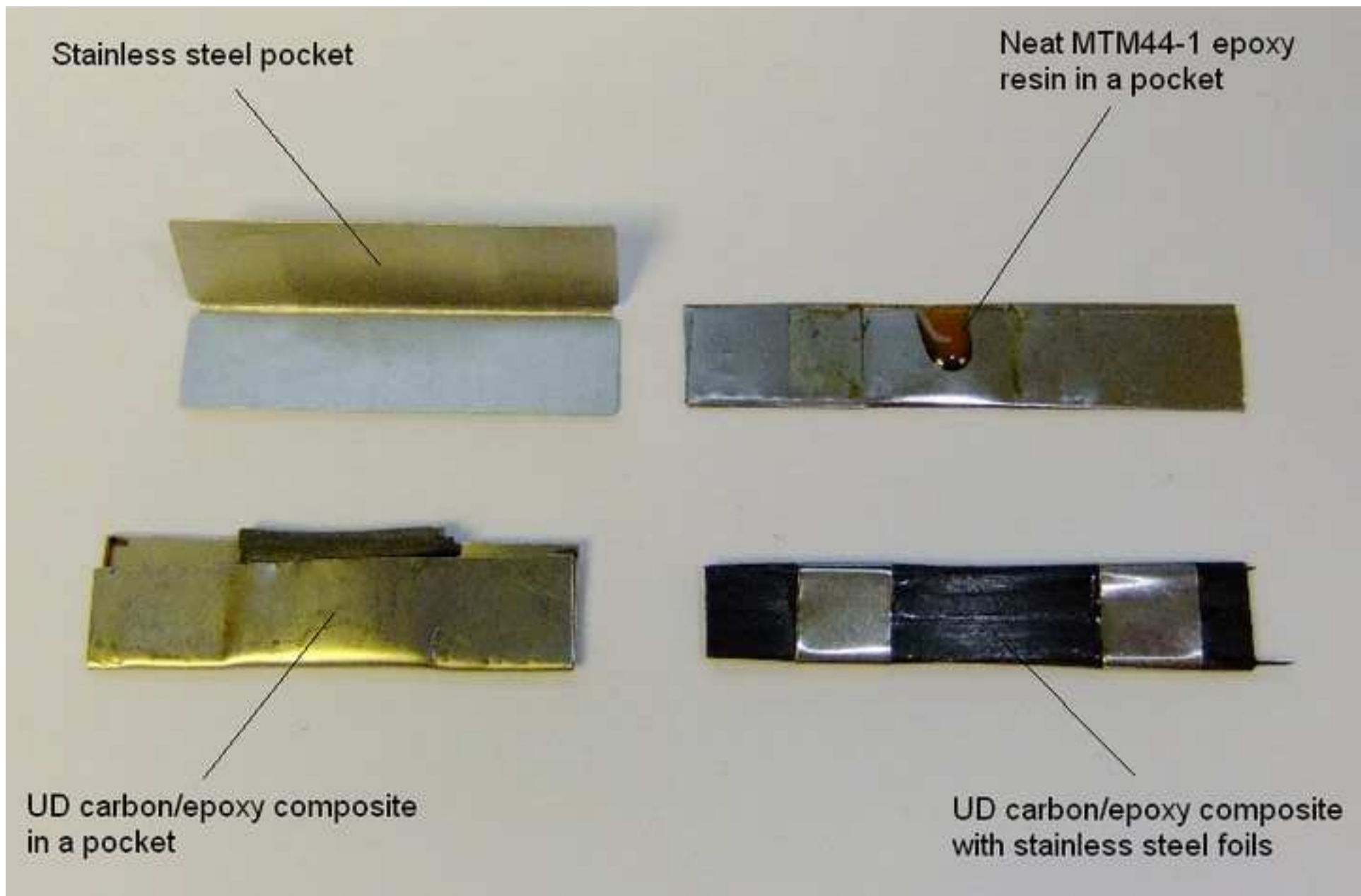


Figure 2

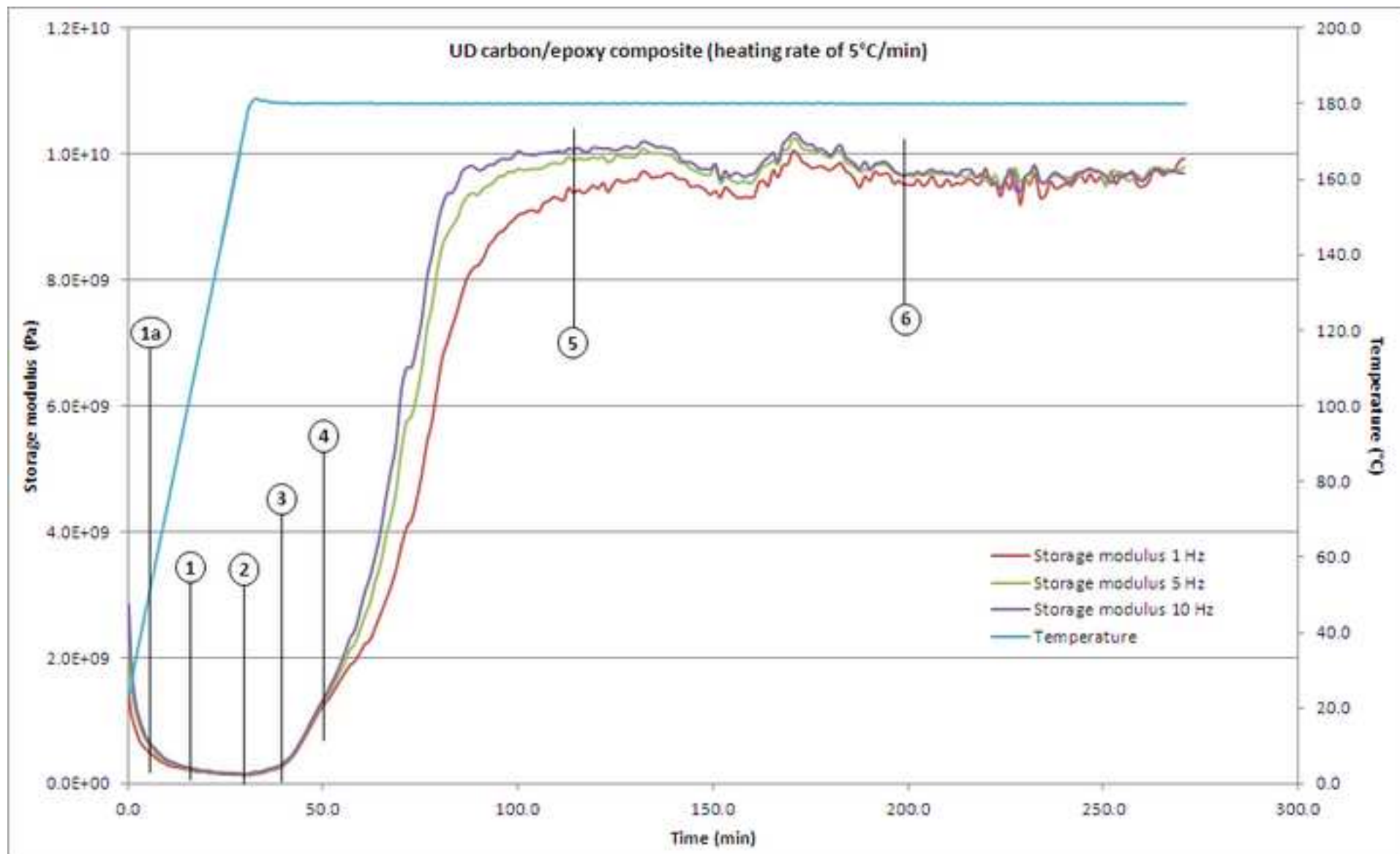


Figure 3

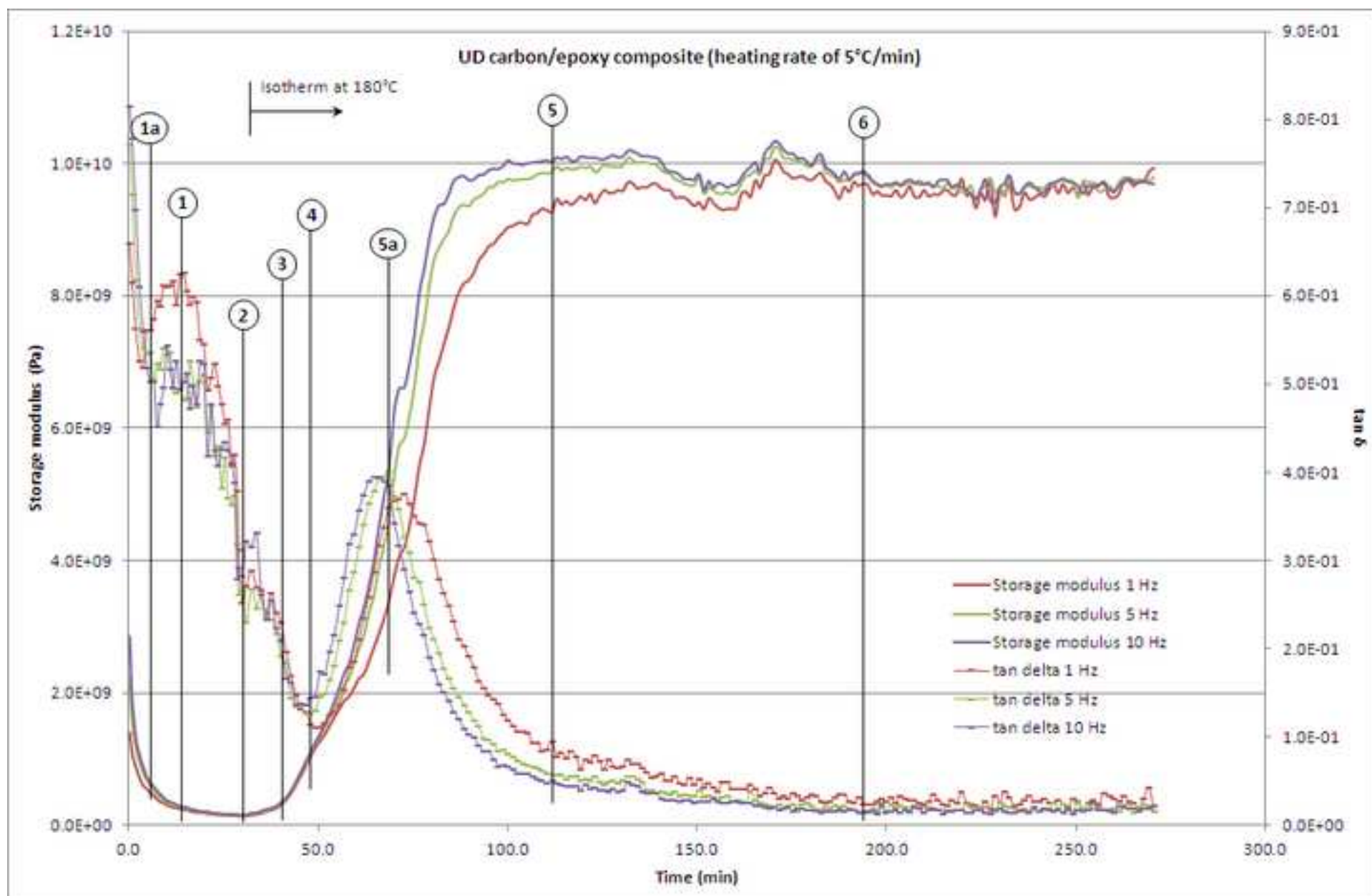


Figure 4

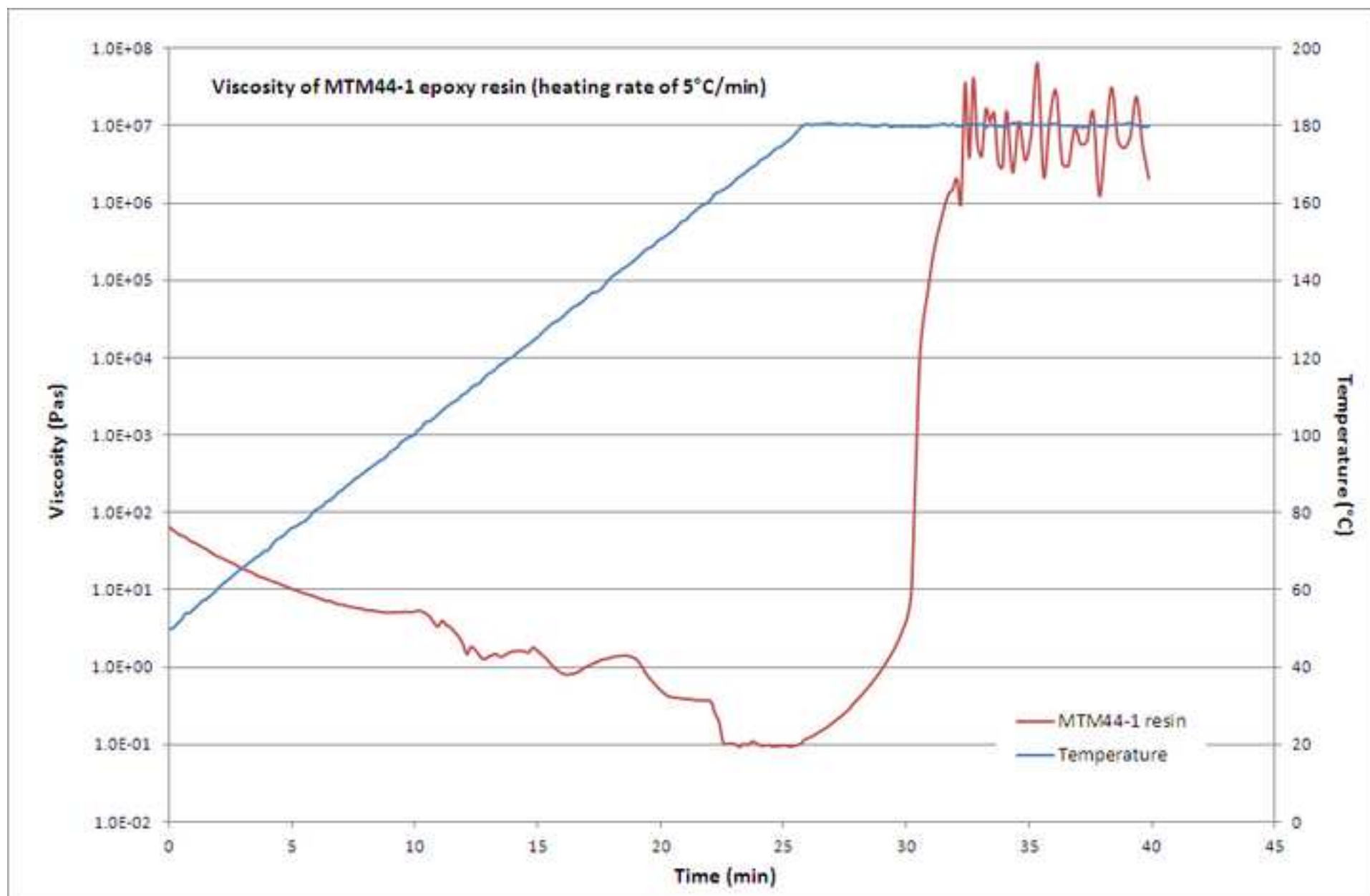


Figure 5

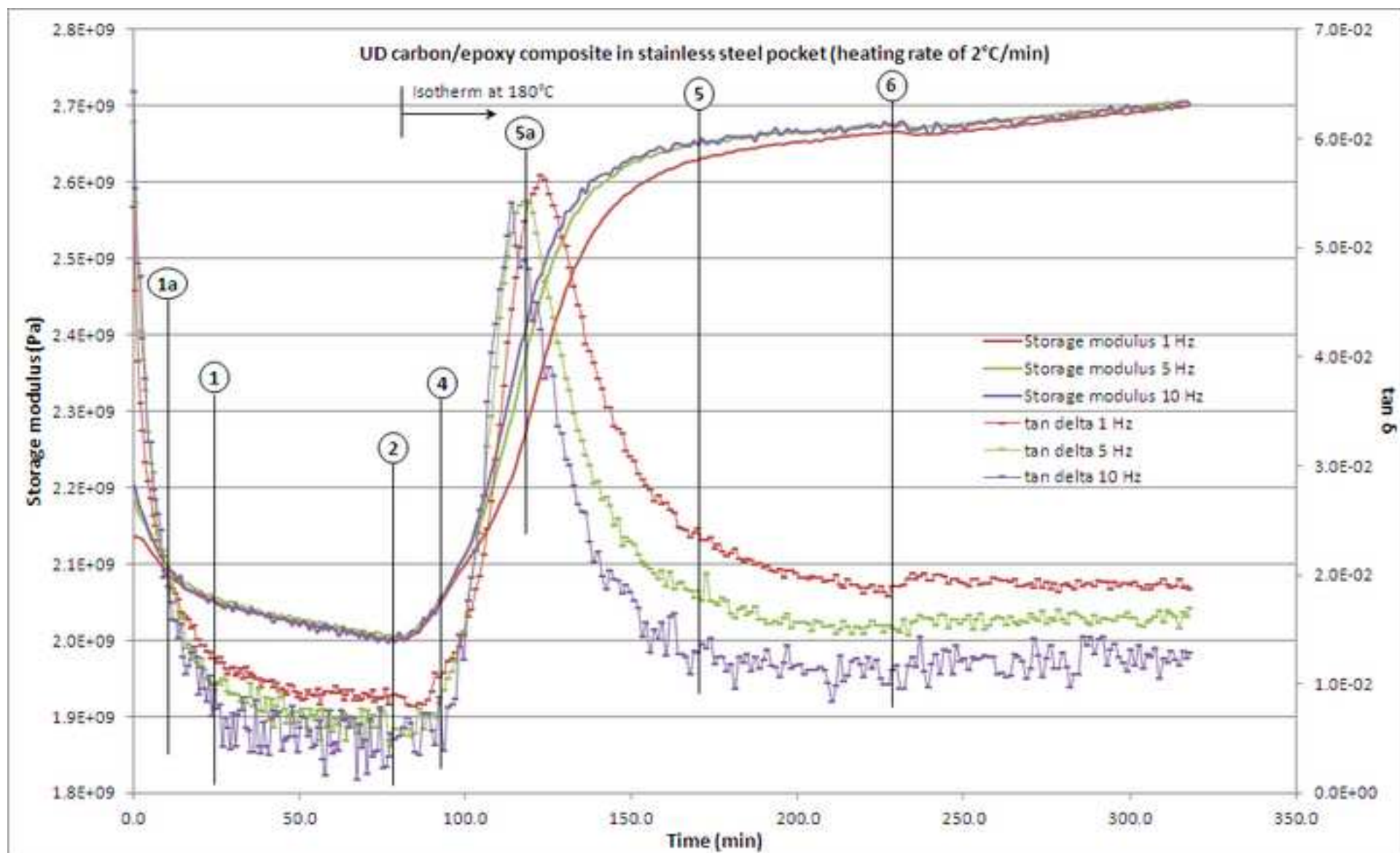
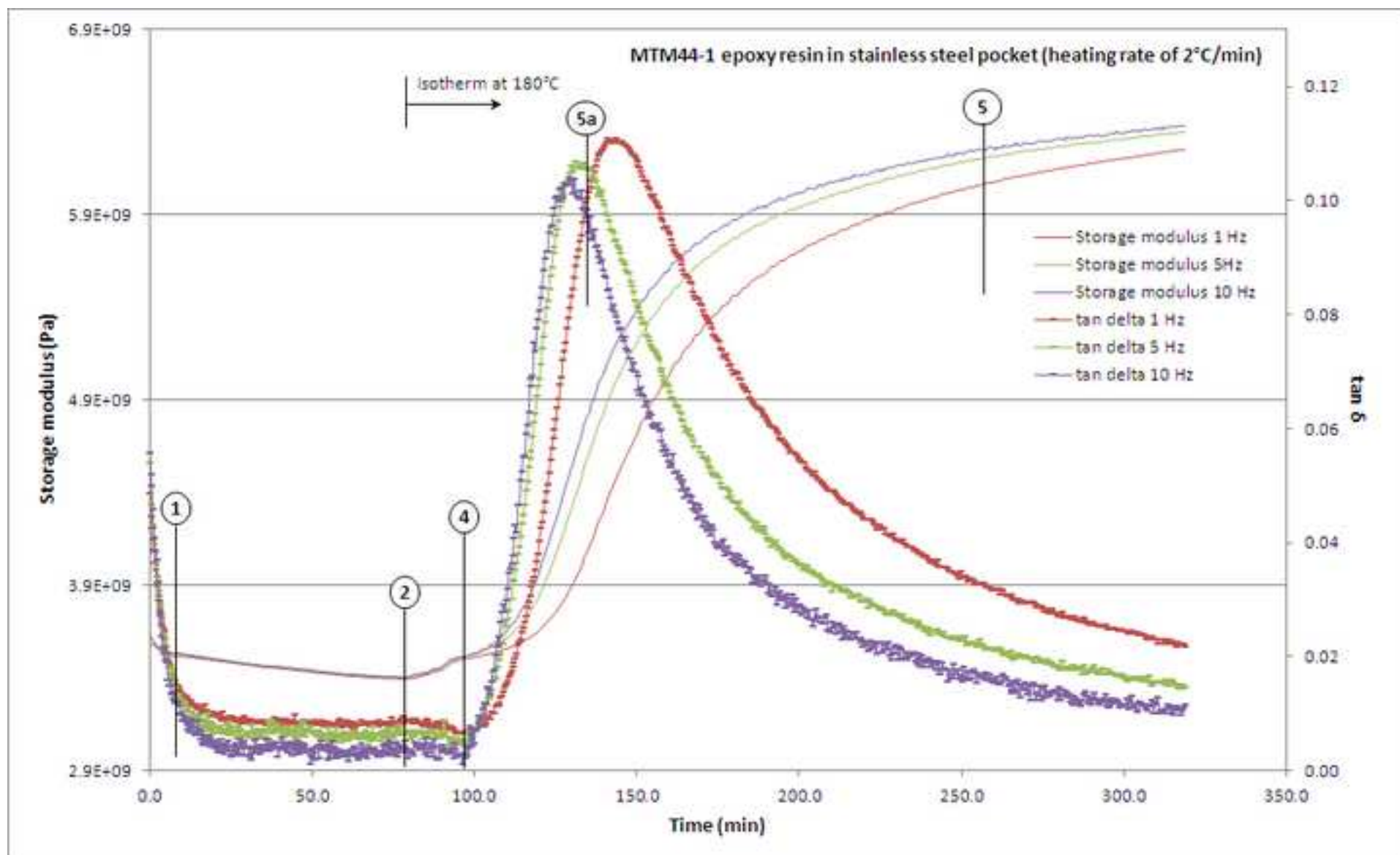




Figure 6



# Cure monitoring of CFRP composites by dynamic mechanical analyser

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